SCAS153A - D3594, JULY 1990 - REVISED APRIL 1993

14 3B

13 3C

12

3D[

 Inputs Are TTL-Voltage Compatible **DW OR NT PACKAGE** (TOP VIEW) Flow-Through Architecture Optimizes **PCB Layout** 24**П** 1В Center-Pin V<sub>CC</sub> and GND Configurations 1Y∏ 23 1 1C **Minimize High-Speed Switching Noise** 1**Z**∏3 22 T 1D EPIC<sup>™</sup> (Enhanced-Performance Implanted 2Y**∏**4 21 2A GND ∏ 5 20 **□** 2B CMOS) 1-µm Process 19 V<sub>CC</sub> GND∏6 500-mA Typical Latch-Up Immunity 18 V<sub>CC</sub> GND ∏ 7 at 125°C GND 18 17 2C Package Options Include Plastic 16 2D 2Z∏9 **Small-Outline Packages and Standard** 3Y**∏** 10 15 3A Plastic 300-mil DIPs 3Z**∏** 11

### description

The 74ACT11802 contains three independent 4-input OR/NOR gates. They perform the Boolean functions in positive logic Y = A + B + C + D and Z =  $\overline{A + B + C + D}$ .

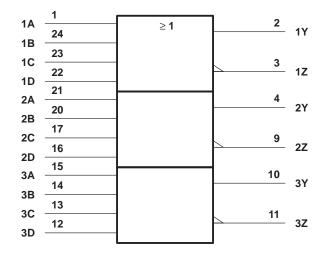
The 74ACT11802 is characterized for operation from -40°C to 85°C.

### **FUNCTION TABLE** (each 4-input gate)

INPUTS				OUT	PUTS
Α	В	С	D	Υ	Z
Н	Χ	Χ	Х	Н	L
Х	Н	Χ	Χ	Н	L
Х	Χ	Н	X	Н	L
Х	Χ	Χ	Н	Н	L
L	L	L	L	L	Н

### logic symbol†

## logic diagram, each section (positive logic)



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<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V <sub>O</sub> (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	±20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	
Continuous current through V <sub>CC</sub> or GND	±150 mA
Storage temperature range	65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
Vсс	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V <sub>IL</sub>	Low-level input voltage			8.0	V
VI	Input voltage	0		VCC	V
VO	Output voltage	0		VCC	V
IOH	High-level output current			-24	mA
loL	Low-level output current			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	ns/V
TA	Operating free-air temperature	-40		85	°C

NOTE 2: Unused or floating inputs must be held high or low.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEGT CONDITIONS	v <sub>cc</sub>	T <sub>A</sub> = 25°C					
PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	MIN	MAX	UNIT
Voн	L 50 A	4.5 V	4.4			4.4		
	ΙΟΗ = – 50 μΑ		5.4			5.4		V
	I <sub>OH</sub> = -24 mA		3.94			3.8		
			4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\ddagger}$	5.5 V				3.85		
VOL	I- 50 u A				0.1		0.1	i
	I <sub>OL</sub> = 50 μA	5.5 V			0.1		0.1	
	04 4	4.5 V			0.36		0.44	V
	I <sub>OL</sub> = 24 mA				0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\ddagger}$	5.5 V					1.65	
lį	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ
∆l <sub>CC</sub> §	One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	5.5 V			0.9		1	mA
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V		4	·			pF

<sup>\*</sup>Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>§</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.



NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

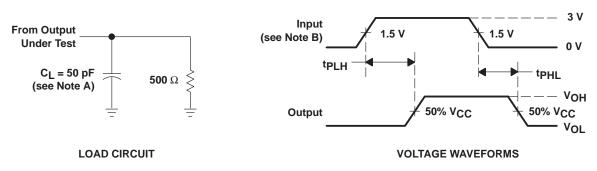
# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C					
			MIN	TYP	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A, B, C, or D	Υ	1.3	6.1	8.4	1.3	9.5	
<sup>t</sup> PHL			1.3	4.8	7.4	1.3	8.1	ns
<sup>t</sup> PLH	A, B, C, or D	7	1.3	4.6	7.5	1.3	8.3	nc
<sup>t</sup> PHL			1	4.6	7.3	1	8.1	ns

### operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per gate	$C_L = 50 \text{ pF},  f = 1 \text{ MHz}$	59	pF

### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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